

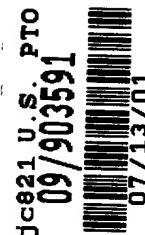


FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L. L. P.
1300 I STREET, N. W.
WASHINGTON, DC 20005-3315

202 • 408 • 4000
FACSIMILE 202 • 408 • 4400

WRITER'S DIRECT DIAL NUMBER:

ATLANTA
404 • 653 • 6400
PALO ALTO
650 • 849 • 6600



TOKYO
011 • 813 • 3431 • 6943
BRUSSELS
011 • 322 • 646 • 0353

(202) 408-4024

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Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

New U.S. Patent Application
Title: COMPUTER SYSTEM AND HEADSET-MOUNTED DISPLAY DEVICE
Inventors and Addresses:

- 1) Ken KISHIDA
Ome-shi, Japan
- 2) Michiyuki TERASAWA
Iruma-shi, Japan
- 3) Nobutaka NAKAMURA
Hidaka-shi, Japan
- 4) Shinichi FURUTA
Akishima-shi, Japan
- 5) Hiroshi NISHIBAYASHI
Ome-shi, Japan
- 6) Tadayuki MATSUBARA
Tokyo, Japan

Sir:

We enclose the following papers for filing in the United States Patent and Trademark Office in connection with the above patent application.

Assistant Commissioner of Patents

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1. Application - 30 pages, including 3 independent claims and 16 claims total.
2. Drawings - 13 sheets of formal drawings containing 19 figures.
3. Certified copy of Japanese Patent Application No. 2000-214514 filed on July 14, 2000.
4. Information Disclosure Statement and Information Disclosure Citation, PTO 1449 with documents attached.
5. The filing fee is calculated as follows:

Basic Application Filing Fee					\$710	\$ 710.00
	Number of Claims		Basic	Extra Claims		
Total Claims	16	-	20	0	x \$18	
Independent Claims	3	-	3	0	x \$80	
<input type="checkbox"/> Presentation of Multiple Dep. Claim					+\$270	
					Subtotal	\$ 710.00
					Reduction by 1/2 if small entity	-
					TOTAL APPLICATION FILING FEE	\$ 710.00

6. A check for \$710.00 is enclosed for the filing fee.

This application is being filed under the provisions of 37 C.F.R. § 1.53(f). Applicants await notification from the Patent and Trademark Office of the time set for filing the Declaration.

Applicants claim the right to priority based on Japanese Patent Application No. 2000-214514 filed on July 14, 2000.

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Enclosures